

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	SHENZHEN NEWCCCESS INDUSTRIAL CO., LTD.	03/06/2024
RECEIVING PARTY DATA		
Company Name:	SHENZHEN NEWFILMS NEW MATERIAL TECHNOLOGY CO., LTD	
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City:	Shenzhen	
State/Country:	CHINA	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	17279845
CORRESPONDENCE DATA		
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NAME OF SUBMITTER:	Mark Gambriel	
SIGNATURE:	Mark Gambriel	
DATE SIGNED:	03/22/2024	
Total Attachments: 1		
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ASSIGNMENT

Whereas, we, SHENZHEN NEWCESS INDUSTRIAL CO., LTD., whose post office address appears below, hereinafter referred to as ASSIGNOR, is the owner of certain new and useful improvements in INSULATING MEDIUM RUBBER FILM AND PRODUCTION METHOD THEREOF AND MULTI-LAYER PRINTED-CIRCUIT BOARD (hereinafter referred to as the INVENTION) for which an application for United States Letters Patent was

__ executed on even date herewith

__ executed on:

☒ filed on: March 25, 2021; Serial No.: 17/279,845

__ established by PCT International Patent Application No.: _____ filed: _____ designating the United States of America


WHEREAS, SHENZHEN NEWFILMS NEW MATERIAL TECHNOLOGY CO., LTD., whose post office address is 301, No. 8, Hou-di-keng-shui-ku Industrial Park, Shi-jia Village Matian Street, Guangming District, Shenzhen, CHINA, hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire right, title and interest in and to the same in the United States;

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, we, ASSIGNOR, by these presents do sell, assign and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application.

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify and communicate to ASSIGNEE at ASSIGNEE'S request documents and information concerning the INVENTION that are within ASSIGNOR'S possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs, executors, administrators and other legal representatives.

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all Letters Patent referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE'S sole use and behoof; and for the use and behoof of ASSIGNEE'S legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

ASSIGNOR authorizes any member of the firm of Maier & Maier, PLLC to insert or complete any information in this document needed to effect its recordal in the U.S. Patent and Trademark Office.

Assignor Name: SHENZHEN NEWCESS INDUSTRIAL CO., LTD.	Address: No. 28, Houdikeng Reservoir Industrial Zone, Jiangshi Community, Gongming Office, Guangming New District, Shenzhen, Guangdong, 518106, China
Where Signed: Shenzhen, China	
Date: March 6, 2024	
Witness (optional)	Signature: <u>XU Laping</u> Printed Name: XU, Laping Title: Legal Representative
Witness (optional)	Witness (optional)

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